

PI3VDP411LS

Digital Video Level Shifter from AC Coupled Digital Video Input to a DVI/HDMI™ Transmitter

Features

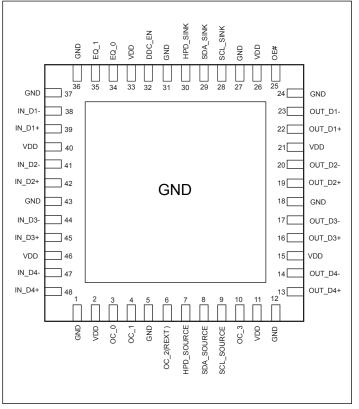
- → Converts low-swing AC coupled differential input to HDMI[™] rev 1.3 compliant open-drain current steering Rx terminated differential output
- → HDMI level shifting operation up to 2.5Gbps per lane (250MHz pixel clock)
- ➔ Integrated 50-ohm termination resistors for AC-coupled differential inputs.
- → Enable/Disable feature to turn off TMDS outputs to enter low-power state.
- → Output slew rate control on TMDS outputs to minimize EMI.
- ➔ Transparent operation: no re-timing or configuration required.
- → 3.3 Power supply required.
- → Integrated ESD protection to 8kV contact on all high speed I/O pins (IN_x and OUT_x) per IEC61000-4-2 test spec, level 4
- ➔ DDC level shifters from 5V from sink side down to 3.3V on source side
- → Level shifter for HPD signal from HDMI/DVI connector
- ➔ Integrated pull-down on HPD_sink input guarantees "input low" when no display is plugged in
- → Packaging (Pb-Free & Green)
 - □ 48 TQFN, 7mm × 7mm (ZDE)
 - 48 TQFN, 7mm x 7mm (ZBE)

Description

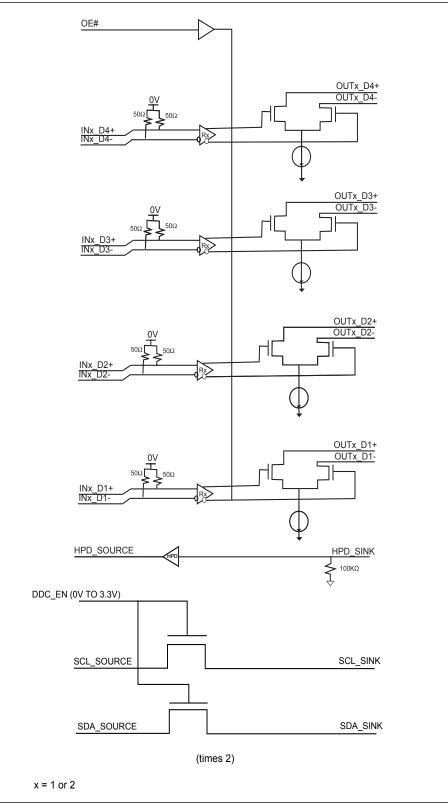
Pericom Semiconductor's PI3VDP411LS provides the ability to use a Dual-mode DP transmitter in HDMI[™] mode. This flexibility provides the user a choice of how to connect to their favorite display. All sinal paths accept AC coupled video signals. The PI3VDP411LS converts this AC coupled signal into an HDMI rev 1.3 compliant signal with proper signal swing. This conversion is automatic and transparent to the user.

The PI3VDP411LS supports up to 2.5Gbps, which provides 12bits of color depth per channel, as indicated in HDMI rev 1.3.

Pin Configuration 48-Pin TQFN (ZDE/ZBE)



Block Diagram



Maximum Ratings (Above which useful life may be impaired. For user guidelines, not tested.)

Storage Temperature–65°C to +150°C
Supply Voltage to Ground Potential0.5V to +5V
DC Input Voltage0.5V to VDD
DC Output Current120mA
Power Dissipation1.0W

Note: Stresses greater than those listed under MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

Table 2: Signal Descriptions

Pin Name	Туре	Description			
		Enable for level shifter path			
05#	5.5V tolerant low-voltage single-	OE#	IN_D Termination	OUT_D Outputs	
OE#	ended input	1	>100KΩ	High-Z	
		0	50Ω	Active	
IN_D4+	Differential input		ng diff input from GMCH differential pair with IN_	*	
IN_D4-	Differential input		ng diff input from GMCH differential pair with IN_		
IN_D3+	Differential input	Low-swing diff input from GMCH PCIE outputs. IN_D3+ makes a differential pair with IN_D3			
IN_D3-	Differential input	Low-swing diff input from GMCH PCIE outputs. IN_D3- makes a differential pair with IN_D3+.			
IN_D2+	Differential input	Low-swing diff input from GMCH PCIE outputs. IN_D2+ makes a differential pair with IN_D2			
IN_D2-	Differential input	Low-swing diff input from GMCH PCIE outputs. IN_D2- makes a differential pair with IN_D2+.			
IN_D1+	Differential input	Low-swing diff input from GMCH PCIE outputs. IN_D1+ makes a differential pair with IN_D1			
IN_D1-	Differential input	Low-swing diff input from GMCH PCIE outputs. IN_D1- makes a differential pair with IN_D1+.			
OUT_D4+	TMDS Differential output	HDMI 1.3 compliant TMDS output. OUT_D4+ makes a d ferential output signal with OUT_D4			
OUT_D4-	TMDS Differential output	HDMI 1.3 compliant TMDS output. OUT_D4– makes a di ferential output signal with OUT_D4+.			
OUT_D3+	TMDS Differential output	HDMI 1.3 compliant TMDS output. OUT_D3+ makes a d ferential output signal with OUT_D3			
OUT_D3-	TMDS Differential output	HDMI 1.3 compliant TMDS output. OUT_D3- makes a differential output signal with OUT_D3+.			

(Continued)

Pin Name	Туре	Description		
OUT_D2+	TMDS Differential output	HDMI 1.3 compliant TMDS ou ential output signal with OUT_		
OUT_D2-	TMDS Differential output	HDMI 1.3 compliant TMDS output. OUT_D2- makes a differ- ential output signal with OUT_D2+.		
OUT_D1+	TMDS Differential output	HDMI 1.3 compliant TMDS ou ential output signal with OUT_		
OUT_D1-	TMDS Differential output	HDMI 1.3 compliant TMDS our ential output signal with OUT_		
HPD_SINK	5V tolerance single-ended input	Low Frequency, 0V to 5V (nominal comes from the HDMI conr "plugged" state; voltage low indi "unplugged". HPD_SINK is pull integrated 100K ohm put-down	nector. Voltage High indicates cated led down by an	
HPD_SOURCE	3.3V single-ended output	HPD_SOURCE: 0V to 3.3V (nominal) output signal. This is level-shifted version of the HPD_SINK signal.		
SCL_SOURCE	Single-ended 3.3V open-drain DDC I/O	3.3V DDC Data I/O. Pulled up by external termination to 3.3V. Connected to SCL_SINK through voltage-limiting integrated NMOS passgate.		
SDA_SOURCE	Single-ended 3.3V open-drain DDC I/O	3.3V DDC Data I/O. Pulled up by external termination to 3.3V. Connected to SDA_SINK through voltage-limiting integrated NMOS passgate.		
SCL_SINK	Single-ended 5V open-drain DDC I/O	5V DDC Clock I/O. Pulled up by external termination to 5V. Connected to SCL_SOURCE through voltage-limiting integrat- ed NMOS passgate.		
SDA_SINK	Single-ended 5V open-drain DDC I/O	5V DDC Data I/O. Pulled up by Connected to SDA_SOURCE th grated NMOS passgate.		
		Enables bias voltage to the DDC passgate level shifter gates. (N be implemented as a bias voltage connection to the DDC pass gates themselves.)		
DDC_EN	5.0V tolerant Single-ended input	DDC_EN	Passgate	
		OV	Disabled	
		3.3V	Enabled	
VDD	3.3V DC Supply	3.3V ± 10%		
OC_2 (REXT)	3.3V single-ended control input	Acceptable connections to OC_ GND; Resistor to 3.3V; NC. (Re		

PERICOM[®]

PI3VDP411LS Digital Video Level Shifter from AC Coupled Digital Video Input to a DVI/HDMI[™] Transmitter

Pin Name	Туре	Description
OC_3	Analog connection to external compo- nent or supply	Acceptable connections to OC_3 pin are: short to 3.3V or to GND; NC.
OC_0		
OC_1	Output and Input jitter elimination	Control pins are to enable Jitter elimination features.
EQ_0	control	For normal operation these pins are tied GND or to VDD. Please see the truth tables for more information.
EQ_1		see the truth tables for more information.

Truth Table 1

OC_3 ⁽²⁾	OC_2 ⁽¹⁾	OC_1 ⁽¹⁾	OC_0 ⁽¹⁾	Vswing (mV)	Pre/De-emphasis
0	0	0	0	500	0
0	0	0	1	600	0
0	0	1	0	750	0
0	0	1	1	1000	0
0	1	0	0	500	0
0	1	0	1	500	1.5dB
0	1	1	0	500	3.5dB
0	1	1	1	500	6dB
1	0	0	0	400	0
1	0	0	1	400	3.5dB
1	0	1	0	400	6dB
1	0	1	1	400	9dB
1	1	0	0	1000	0
1	1	0	1	1000	-3.5dB
1	1	1	0	1000	-6dB
1	1	1	1	1000	-9dB

Truth Table 2

EQ_1 ⁽²⁾	EQ_0 ⁽¹⁾	Equalization @ 1.25GHz (dB)
0	0	3
0	1	6
1	0	9
1	1	12

Notes:

1) These signals have internal 100kW pull-ups.

2) For 48-TQFN package, these signals have internal 100kW pull-ups, with external connection.

Electrical Characteristics

Table 3: Power Supplies and Temperature Range

Symbol	Parameter	Min	Nom	Max	Units	Comments
V _{DD}	3.3V Power Sup- ply	3.0	3.3	3.6	V	
I _{CC}	Max Current			100	mA	Total current from V_{DD} 3.3V supply when de-emphasis/pre-emphasis is set to 0dB.
I _{CCQ}	Standby Cur- rent Consump- tion			2	mA	OE# = HIGH
T _{CASE}	Case temperature range for opera- tion with spec.	-40		85	Celcius	

Table 4: OE# Description

OE#	Device State	Comments			
Asserted (low voltage)	serted (low voltage) Differential input buffers and output buffers 1 enabled. Input impedance = 50Ω				
Unasserted (high voltage)	Low-power state. Differential input buffers and termination are disabled. Differential inputs are in a high- impedance state. OUT_D level-shifting outputs are disabled. OUT_D level-shifting outputs are in high- impedence state. Internal bias currents are turned off.	 Intended for lowest power condition when: No display is plugged in or The level shifted data path is disabled HPD_SINK input and HPD_SOURCE output are not affected by OE# SCL_SOURCE, SCL_SINK, SDA_SOURCE and SDA_SINK signals and functions are not affected by OE# 			

Table 5: Differential Input Characteristics for IN_D and RX_IN signals

Symbol	Parameter	Min	Nom	Max	Units	Comments
Tbit	Unit Interval	360			ps	Tbit is determined by the display mode. Nomi- nal bit rate ranges from 250Mbps to 2.5Gbps per lane. Nominal Tbit at 2.5 Gbps=400ps. 360ps=400ps-10%
V _{RX-DIFFp-p}	Differential Input Peak to Peak Voltage	0.175		1.200	v	VRX-DIFFp-p=2' VRX-D+ x VRX-D- Applies to IN_D and RX_IN signals
T _{RX-EYE}	Minimum Eye Width at IN_D input pair	0.8			Tbit	The level shifter may add a maximum of 0.02UI jitter
V _{CM-AC-pp}	AC Peak Common Mode Input			100	mV	VCM-AC-pp = VRX-D+ + VRX-D- /2 - VRX-CM-DC. $VRX-CM-DC = DC(avg) of VRX-D+ + VRX-D = VRX-D $
and the FF	Voltage					D- /2 VCM-AC-pp includes all frequencies above 30 kHz.
Z _{RX-DC}		40	50	60	Ω	Required IN_D+ as well as IN_D- DC imped- ance ($50\Omega \pm 20\%$ tolerance).
V _{RX-Bias}		0		2.0	V	Intended to limit power-up stress on chipset's PCIE output buffers.
Z _{RX-HIGH-Z}		100			kΩ	Differential inputs must be in a high impedance state when OE# is HIGH.

TMDS Outputs

The level shifter's TMDS outputs are required to meet HDMI 1.3 specifications.

The HDMI 1.3 Specification is assumed to be the correct reference in instances where this document conflicts with the HDMI 1.3 specification.

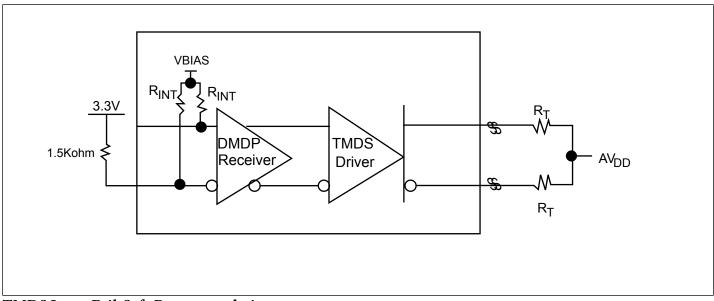
Table 6: Differential Output Characteristics for TMDS_OUT signals

Symbol	Parameter	Min	Nom	Max	Units	Comments
V _H	Single-ended high level output voltage	V _{DD} -10mV	V _{DD}	V _{DD} +10mV	V	VDD is the DC termination voltage in the HDMI or DVI Sink. VDD is nominally 3.3V
VL	Single-ended low level output voltage	V _{DD} -600mV	V _{DD} -500mV	V _{DD} -400mV	V	The open-drain output pulls down from VDD.
V _{SWING}	Single-ended out- put swing voltage	450mV	500mV	600mV	V	Swing down from TMDS termination voltage (3.3V ± 10%)
I _{OFF}	Single-ended current in high-Z state			50	μA	Measured with TMDS outputs pulled up to VDD Max _(3.6V) through 50Ω resistors.
T _R	Rise time	125ps		0.4Tbit	ps	Max Rise/Fall time @2.7Gbps = 148ps. 125ps = 148-15%
T _F	Fall time	125ps		0.4Tbit	ps	Max Rise/Fall time @2.7Gbps = 148ps. 125ps = 148-15%
T _{SKEW-INTRA}	Intra-pair differential skew			30	ps	This differential skew budget is in addition to the skew presented between D+ and D- paired input pins. HDMI revision 1.3 source allowable intra-pair skew is 0.15Tbit.
T _{SKEW-INTER}	Inter-pair lane- to-lane output skew			100	ps	This lane-to-lane skew budget is in addition to skew be- tween differential input pairs
T _{JIT}	Jitter added to TMDS signals			25	ps	Jitter budget for TMDS sig- nals as they pass through the level shifter. 25ps = 0.056 Tbit at 2.25 Gb/s



TMDS Output Oscillation Elimination

The inputs do not incorporate a squelch circuit. Therefore, we reccomend the input to be externally biased to prevent output oscillation. Pericom reccomends to add a 1.5Kohm pull-up to the CLK- input.



TMDS Input Fail-Safe Recommendation

Table 8: HPD Input Characteristics

Symbol	Parameter	Min	Nom	Max	Units	Comments
V _{IH-HPD}	Input High Level	2.0	5.0	5.3	V	Low-speed input changes state on cable plug/ unplug
V _{IL-HPD}	HPD_sink Input Low Level	0		0.8	V	
I _{IN-HPD}	HPD_sink Input Leakage Current			70	μΑ	Measured with HPD_sink at $\rm V_{IH\text{-}HPD}$ max and $\rm V_{IL\text{-}HPD}$ min
V _{OH-HPDB}	HPD_sink Output High-Level	2.5		V _{DD}	V	$V_{DD} = 3.3V \pm 10\%$
V _{OL-HPDB}	HPD_sink Output Low-Level	0		0.02	V	
T _{HPD}	HPD_sink to HPD_ source propagation delay			200	ns	Time from HPD_sink changing state to HPD_source changing state. Includes HPD_ source rise/fall time
T _{RF-HPDB}	HPD_source rise/fall time	1		20	ns	Time required to transition from $V_{OH\text{-}HPDB}$ to $V_{OL\text{-}HPDB}$ or from $V_{OL\text{-}HPDB}$ to $V_{OH\text{-}HPDB}$

Table 9: OE# Input and DDC_EN

Symbol	Parameter	Min	Nom	Max	Units	Comments
V _{IH}	Input High Level	2.0		VDD	V	TMDS enable input changes state on cable plug/unplug
V _{IL}	Input Low Level	0		0.8	V	
I _{IN}	Input Leakage Current			10	μΑ	Measured with input at $V_{\text{IH-EN}}\text{max}$ and $V_{\text{IL-EN}}\text{min}$

Table 10: Termination Resistors

Symbol	Parameter	Min	Nom	Max	Units	Comments
R _{HPD}	HPD_sink input pull- down resistor.	80K	100k	120K	Ω	Guarantees HPD_sink is LOW when no display is plugged in.

Recommended Power Supply Decoupling Circuit

Figure 1 is the recommended power supply decoupling circuit configuration. It is recommended to put 0.1μ F decoupling capacitors on each VDD pins of our part, there are four 0.1μ F decoupling capacitors are put in Figure 1 with an assumption of only four VDD pins on our part, if there is more or less VDD pins on our Pericom parts, the number of 0.1μ F decoupling capacitors should be adjusted according to the actual number of VDD pins. On top of 0.1μ F decoupling capacitors on each VDD pins, it is recommended to put a 10μ F decoupling capacitor near our part's VDD, it is for stabilizing the power supply for our part. Ferrite bead is also recommended for isolating the power supply for our part and other power supplies in other parts of the circuit. But, it is optional and depends on the power supply conditions of other circuits.

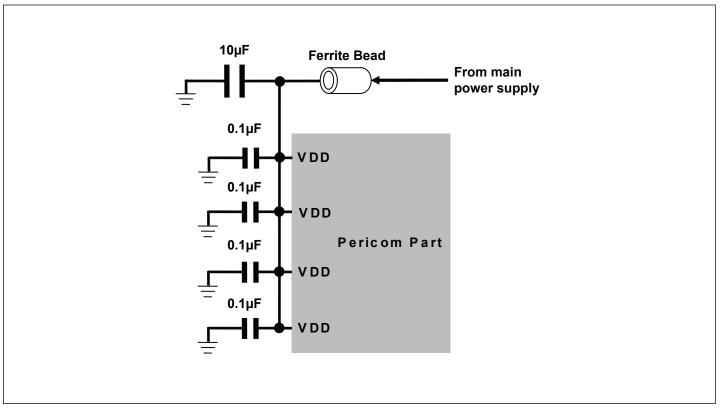


Figure 1 Recommended Power Supply Decoupling Circuit Diagram



Requirements on the Decoupling Capacitors

There is no special requirement on the material of the capacitors. Ceramic capacitors are generally being used with typically materials of X5R or X7R.

Layout and Decoupling CapacitorPlacement Consideration

- i. Each $0.1\mu F$ decoupling capacitor should be placed as close as possible to each V_{DD} pin.
- ii. V_{DD} and GND planes should be used to provide a low impedance path for power and ground.
- iii. Via holes should be placed to connect to V_{DD} and GND planes directly.
- iv. Trace should be as wide as possible
- v. Trace should be as short as possible.
- vi. The placement of decoupling capacitor and the way of routing trace should consider the power flowing criteria.
- vii. 10µF capacitor should also be placed closed to our part and should be placed in the middle location of 0.1µF capacitors.
- viii. Avoid the large current circuit placed close to our part; especially when it is shared the same V_{DD} and GND planes. Since large current flowing on our V_{DD} or GND planes will generate a potential variation on the V_{DD} or GND of our part.

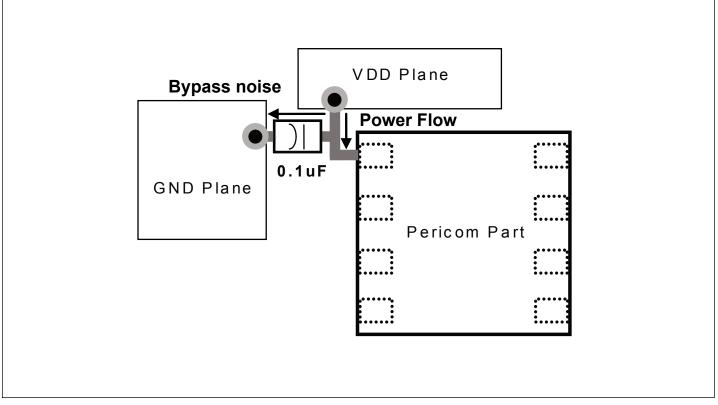
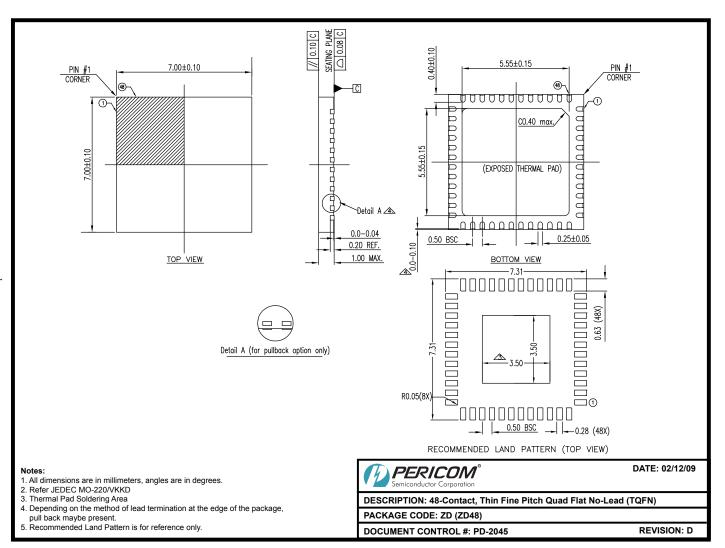


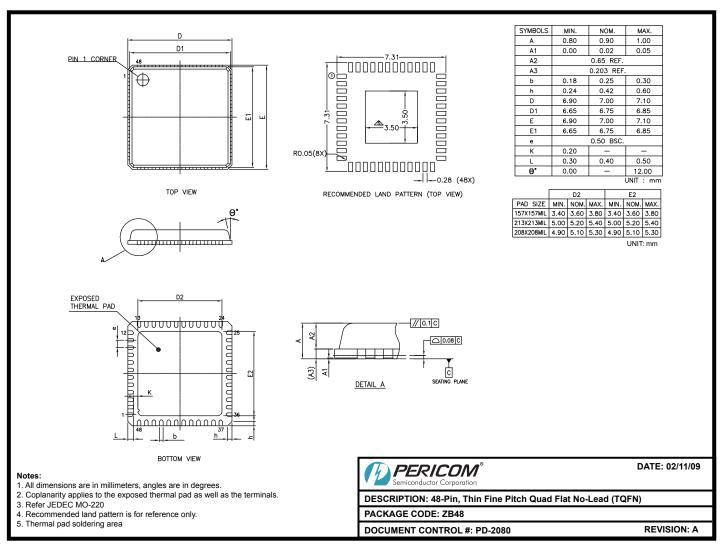
Figure 2 Layout and Decoupling Capacitor Placement Diagram



09-0117

PERICOM®

PI3VDP411LS Digital Video Level Shifter from AC Coupled Digital Video Input to a DVI/HDMI[™] Transmitter



09-0091

Note:

[□] For latest package info, please check: http://www.pericom.com/products/packaging/mechanicals.php

Ordering Information

Ordering Code	Package Code	Package Description
PI3VDP411LSZBE	ZBE	48-pin Pb-free & Green, TQFN
PI3VDP411LSZDE	ZDE	48-pin Pb-free & Green, TQFN

Notes:

- Thermal characteristics can be found on the company web site at www.pericom.com/packaging/
- E = Pb-free and Green
- Adding an X Suffix = Tape/Reel

Pericom Semiconductor Corporation • 1-800-435-2336 • www.pericom.com

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Pericom: <u>PI3VDP411LSZBEX</u> PI3VDP411LSZBE